

# Hymite Corporate Fact Sheet



<b>Overview</b>	Hymite designs, develops and manufacture innovative silicon-based wafer-scale packages for high-volume electronic component applications.	
<b>Corporate Structure</b>	Privately held	
<b>History</b>	Founded in 1999 by Jochen Kuhmann and Matthias Heschel	
<b>Target Market</b>	Suppliers of LEDs, MEMs, and RF components	
<b>Products</b>	<b>HyLED™</b> – packaging technology that meets the requirements of the high-brightness LED market. <b>HyCap®</b> – hermetic encapsulation of MEMS components.	
<b>Competitive Advantages</b>	Hymite’s innovative silicon packaging enables customers to shrink package size, improve thermal performance, maintain hermeticity, and cut costs through wafer-scale production.	
<b>Management</b>	Claus Jørgen Nielsen – CEO Jochen Kuhmann – CTO and Founder Matthias Heschel – VP Engineering, Co-founder Christoffer Kay – CFO Eric Leonard – Director of World Wide Sales Jørgen Høg – Director of Business Development	
<b>Headquarters</b>	<b>Denmark</b> Hymite A/S Diplomvej, building 376 DK-2800 Kgs. Lyngby Denmark Telephone : +45 45 25 91 40 Telefax : +45 45 25 91 56	
<b>Offices</b>	<b>Berlin, Germany</b> Hymite GmbH Carl-Scheele-Str. 12 D-12489 Berlin Germany Telephone :+49 30	<b>U.S. Sales Office</b> Hymite INC. 773 Justin Road Rockwall, TX 75087 Telephone:+1 972 722 6700

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